



VM3003

30V Dual N-Channel MOSFETs

General Description

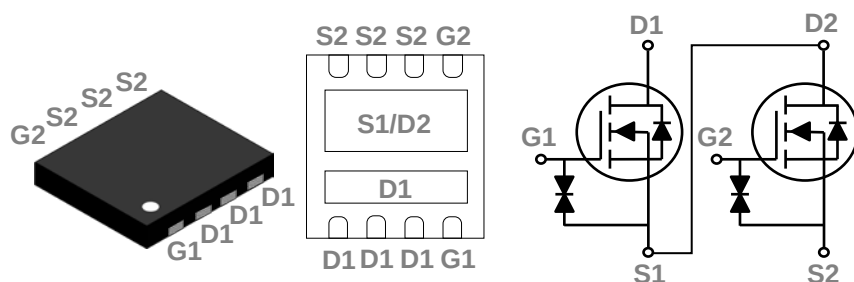
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

	BVDSS	RDSON	ID
Q1	30V	6.8mΩ	40A
Q2	30V	6.8mΩ	40A

Features

- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available
- ESD Protection Embedded

DFN3x3 Asymmetric Dual Pin Configuration



Applications

- MB / VGA / Vcore
- POL Buck Applications
- SMPS 2nd SR

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Q1	Q2	Units
V_{DS}	Drain-Source Voltage	30	30	V
V_{GS}	Gate-Source Voltage	± 20	± 20	V
I_D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	40	40	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	25	25	A
	Drain Current – Continuous ($T_A=25^\circ\text{C}$)	13	13	A
	Drain Current – Continuous ($T_A=100^\circ\text{C}$)	8	8	A
I_{DM}	Drain Current – Pulsed ¹	160	160	A
EAS	Single Pulse Avalanche Energy ²	45	45	mJ
IAS	Single Pulse Avalanche Current ²	30	30	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)	18	18	W
	Power Dissipation – Derate above 25°C	0.15	0.15	W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150		$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150		$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$ Q1	Thermal Resistance Junction to ambient	---	62	$^\circ\text{C/W}$
$R_{\theta JA}$ Q2		---	62	$^\circ\text{C/W}$
$R_{\theta JC}$ Q1	Thermal Resistance Junction to Case	---	6.9	$^\circ\text{C/W}$



Electrical Characteristics (T _J =25 °C, unless otherwise noted)	---	6.9	°C/W
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Static State Characteristics

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	Q1	30	---	---	V
			Q2	30	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =27V, V _{GS} =0V, T _J =25°C	Q1	---	---	1	μA
			Q2	---	---	1	μA
		V _{DS} =24V, V _{GS} =0V, T _J =85°C	Q1	---	---	10	μA
			Q2	---	---	10	μA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	Q1	---	---	±20	μA
			Q2	---	---	±20	μA
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =15A	Q1	---	5.7	6.8	mΩ
		V _{GS} =10V, I _D =15A	Q2	---	5.7	6.8	mΩ
		V _{GS} =4.5V, I _D =10A	Q1	---	8.6	11.2	mΩ
		V _{GS} =4.5V, I _D =10A	Q2	---	8.6	11.2	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250μA	Q1	1.2	1.6	2.5	V
			Q2	1.2	1.6	2.5	V

Dynamic Characteristics³

Q _g	Total Gate Charge	V _{DS} =15V , V _{GS} =10V , I _D =20A	Q1	---	13	25	nC	
			Q2	---	13	25		
			Q1	---	6.3	12		
			Q2	---	6.3	12		
Q _{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =20A	Q1	---	1.1	3		
			Q2	---	1.1	3		
			Q _{gd}	Gate-Drain Charge		Q1		---
Q2	---			2.2	5			
T _{d(on)}	Turn-On Delay Time	V _{DD} =15V , V _{GS} =10V , R _G =6Ω I _D =20A	Q1	---	2.5	5	ns	
			Q2	---	2.5	5		
			T _r	Rise Time		Q1		---
Q2	---			3	6			
T _{d(off)}	Turn-Off Delay Time		Q1	---	5	10		
			Q2	---	5	10		
			T _f	Fall Time		Q1		---
Q2	---			8	16			



C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , F=1MHz	Q1	---	680	1400	pF
			Q2	---	680	1400	
C _{oss}	Output Capacitance		Q1	---	507	1000	
			Q2	---	507	1000	
C _{rss}	Reverse Transfer Capacitance		Q1	---	27	60	
			Q2	---	27	60	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	Q1	---	1.5	---	Ω
			Q2	---	1.5	---	

Drain-Source Diode Characteristics

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V , Force Current	Q1	---	---	40	A
			Q2	---	---	40	A
I _{SM}	Pulsed Source Current		Q1	---	---	80	A
			Q2	---	---	80	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25°C	Q1	---	---	1	V
			Q2	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=25V, V_{GS}=10V, L=0.1mH, Q1: I_{AS}=30A, Q2: I_{AS}=30A, R_G=25Ω, Starting T_J=25°C.
3. Essentially independent of operating temperature.

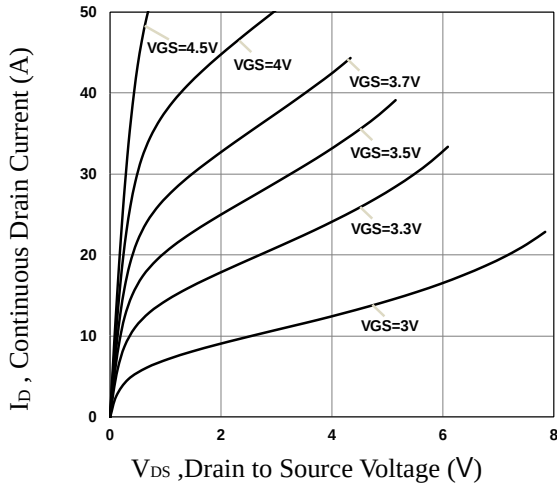


Fig.1 Q1 Typical Output Characteristics

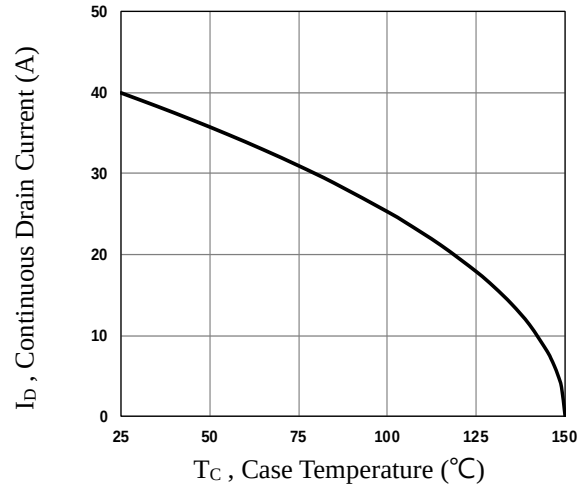


Fig.2 Q1 Continuous Drain Current vs. T_C

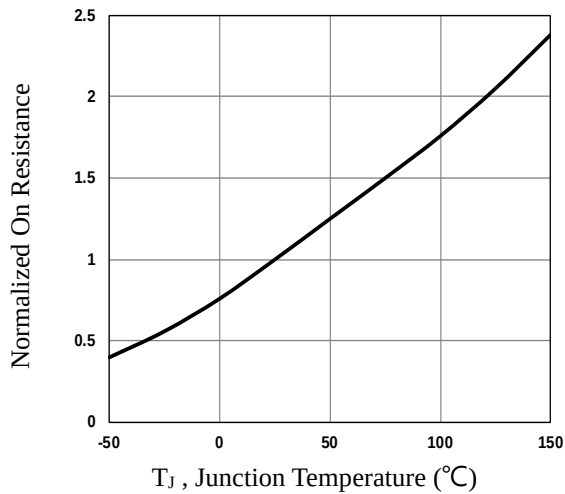


Fig.3 Q1 Normalized $R_{DS(on)}$ vs. T_J

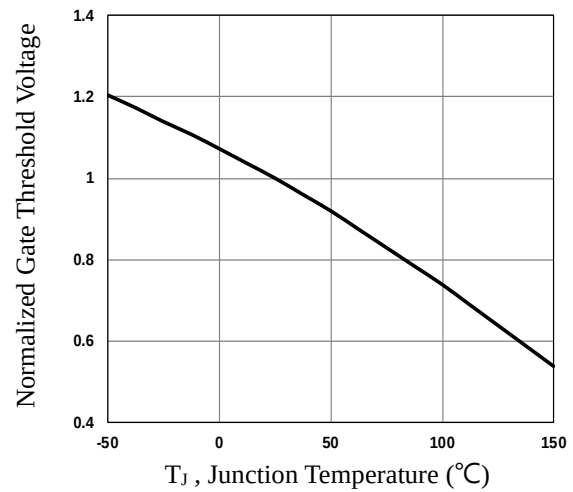


Fig.4 Q1 Normalized V_{th} vs. T_J

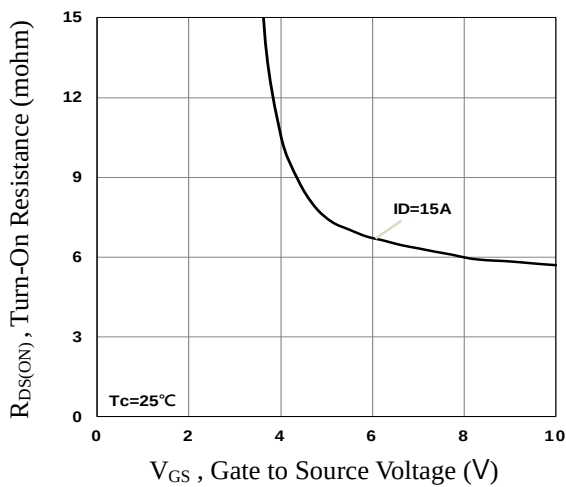


Fig.5 Q1 Turn-On Resistance vs. V_{GS}

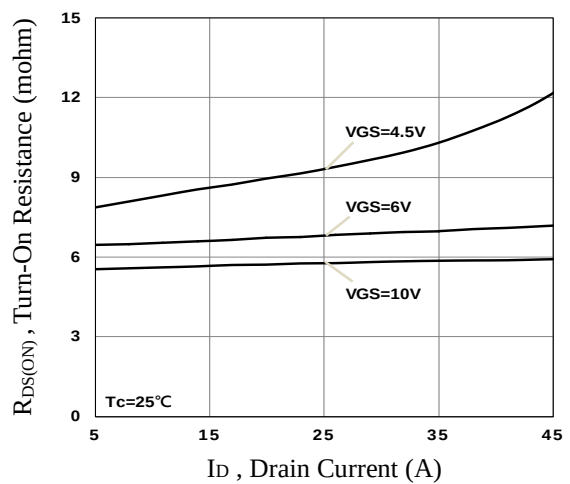


Fig.6 Q1 Turn-On Resistance vs. I_D

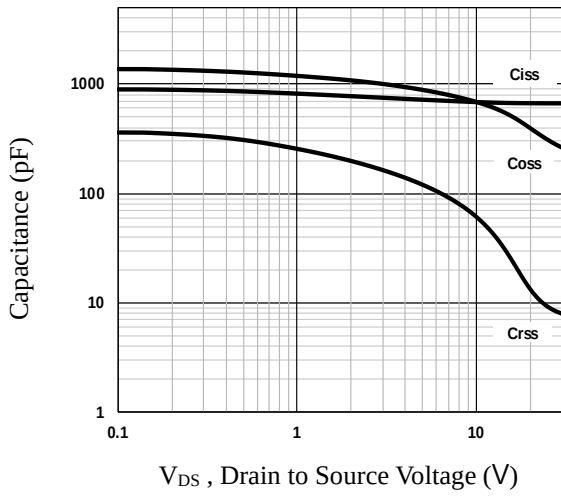


Fig.7 Q1 Capacitance Characteristics

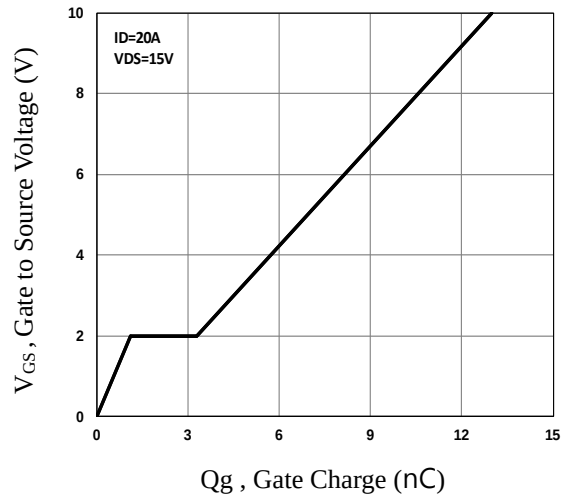


Fig.8 Q1 Gate Charge Characteristics

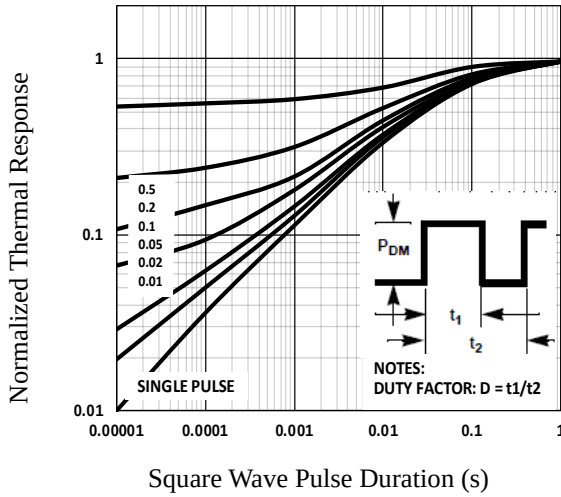


Fig.9 Q1 Normalized Transient Impedance

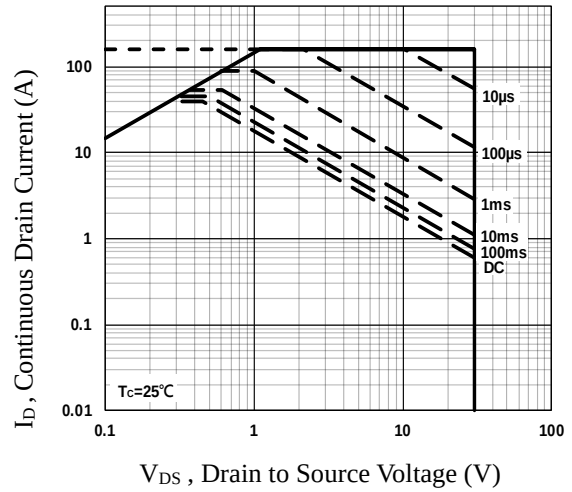


Fig.10 Q1 Maximum Safe Operation Area

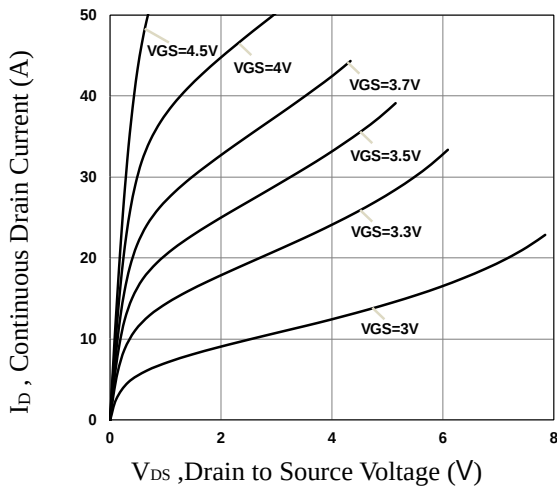


Fig.11 Q2 Typical Output Characteristics

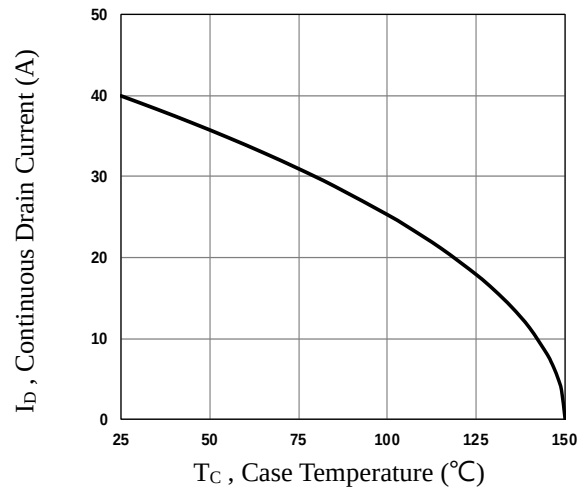


Fig.12 Q2 Continuous Drain Current vs. T_C

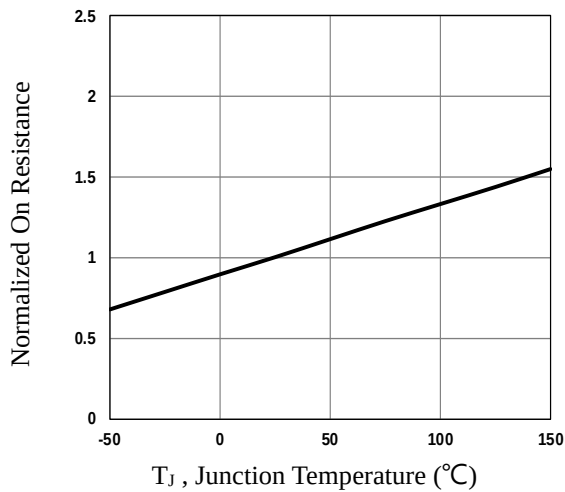


Fig.13 Q2 Normalized $R_{DS(ON)}$ vs. T_J

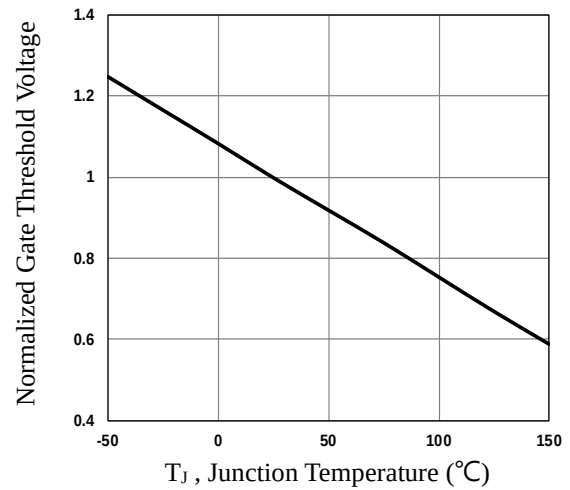


Fig.14 Q2 Normalized V_{th} vs. T_J

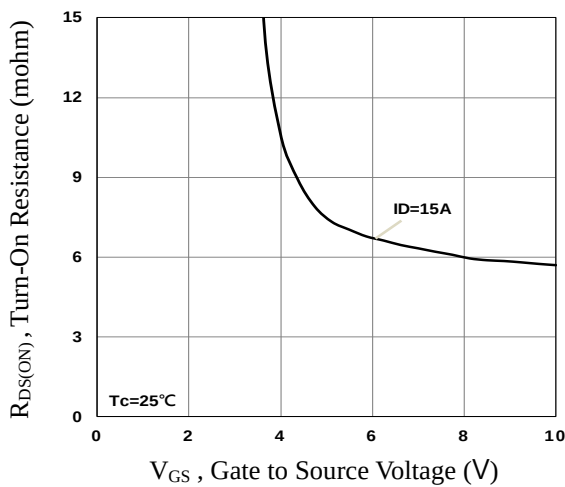


Fig.15 Q2 Turn-On Resistance vs. V_{GS}

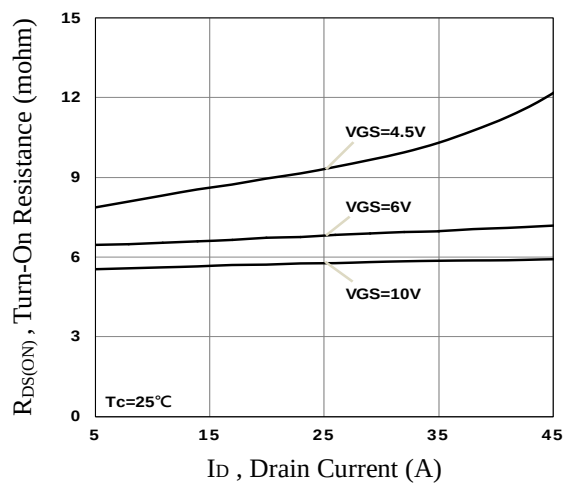


Fig.16 Q2 Turn-On Resistance vs. I_D

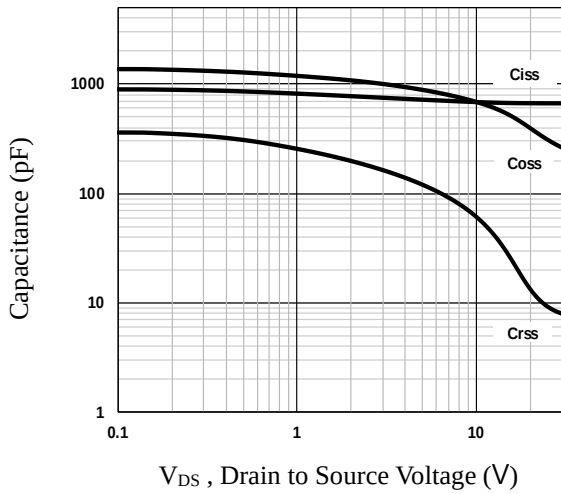


Fig.17 Q2 Capacitance Characteristics

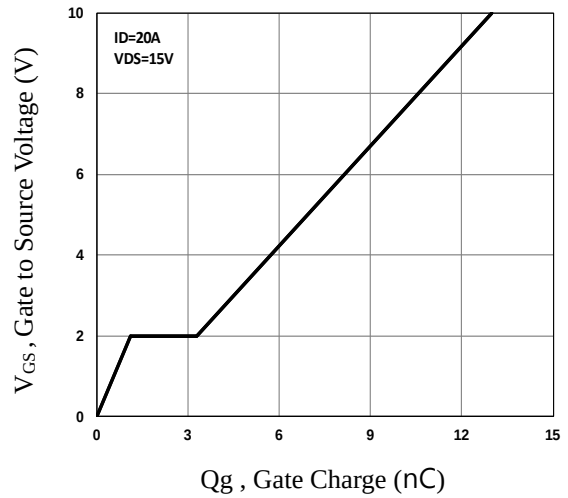


Fig.18 Q2 Gate Charge Characteristics

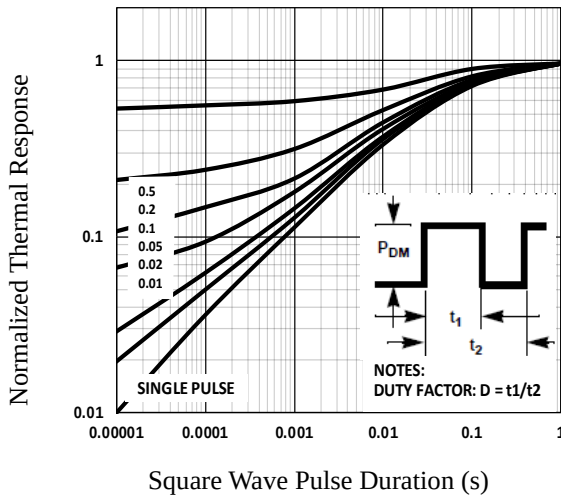


Fig.19 Q2 Normalized Transient Impedance

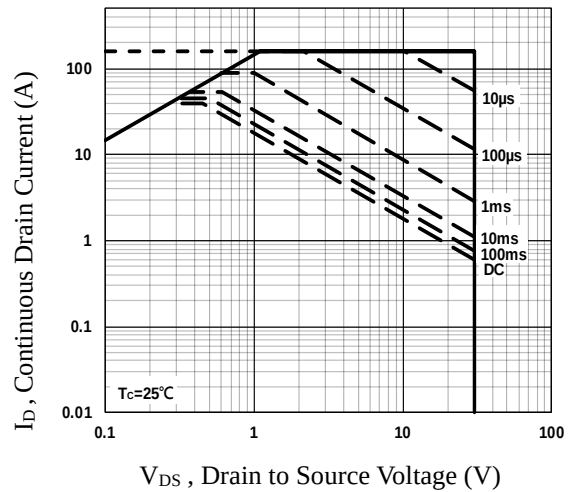


Fig.20 Q2 Maximum Safe Operation Area

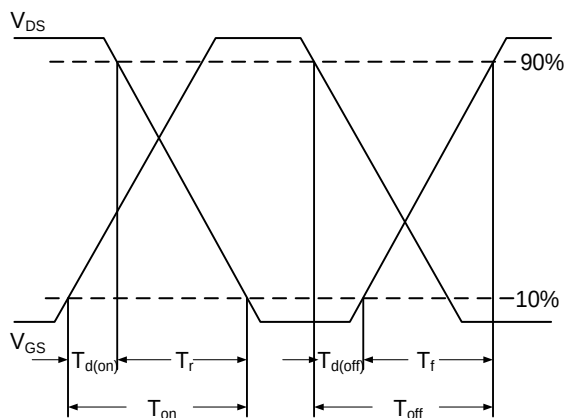


Fig.21 Switching Time Waveform

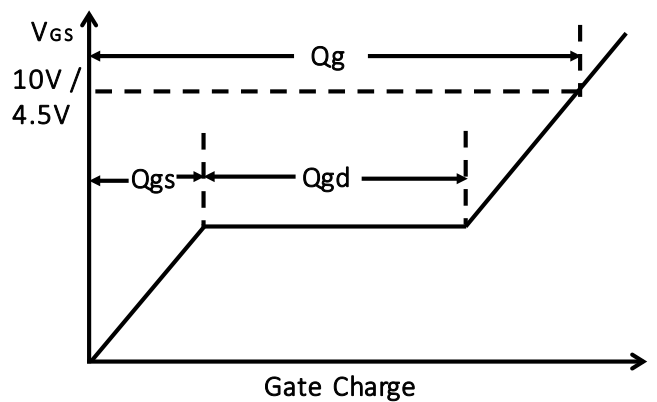
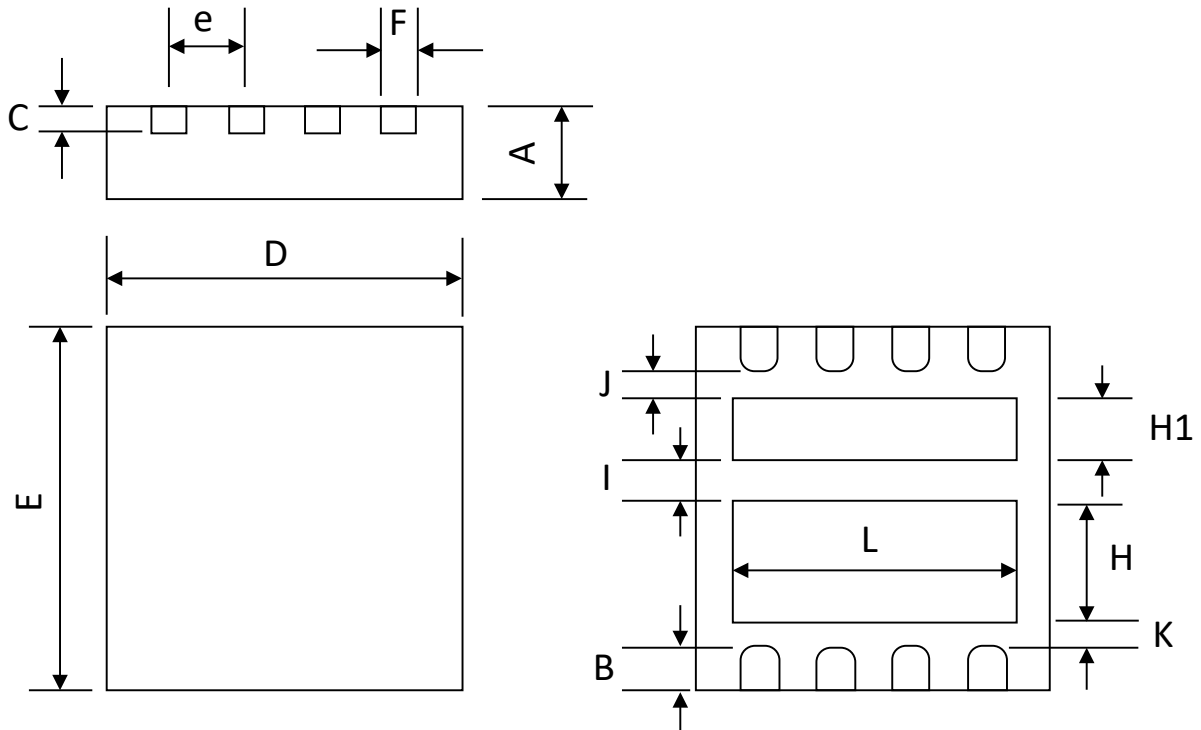


Fig.22 Gate Charge Waveform



DFN3x3 Asymmetric Dual Package Information

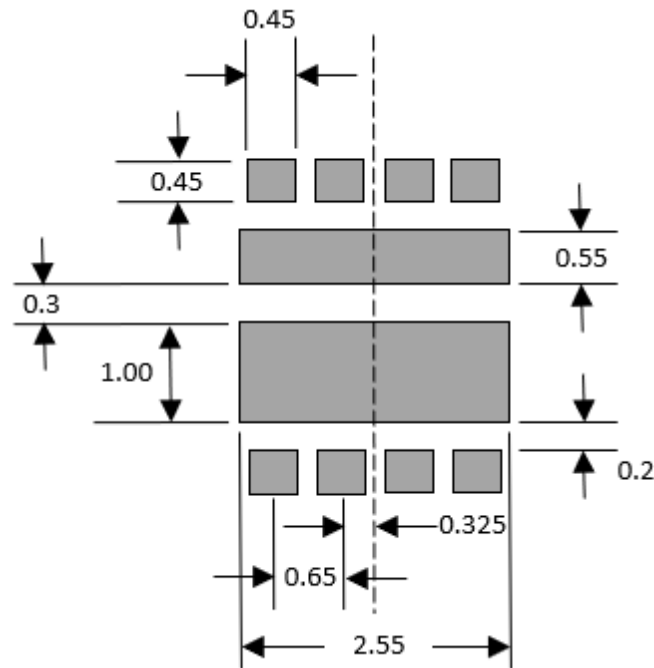


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Max	Min	Max	Min
A	0.900	0.700	0.035	0.028
B	0.400	0.250	0.016	0.010
C	0.255	0.150	0.010	0.006
D	3.100	2.900	0.122	0.114
E	3.100	2.900	0.122	0.114
e	0.650 BSC		0.026 BSC	
F	0.450	0.250	0.018	0.010
H	1.100	0.850	0.043	0.033
H1	0.650	0.400	0.026	0.016
I	0.450	0.250	0.018	0.010
J	0.350	0.150	0.014	0.006
K	0.350	0.150	0.014	0.006
L	2.500	2.200	0.098	0.087



RECOMMENDED LAND PATTERN

DFN3X3 (Asymmetric Dual)



unit : mm

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